Product data sheet

1. General description

Dual Silicon Carbide Schottky diode in a TO247 plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- · New 6th Generation Technology
- · Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Forward Surge Capability I_{FSM}
- Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant
- AEC-Q101 qualified

3. Applications

- Power factor correction
- · Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives
- · On board charger

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	s Values			Unit
Absolute	maximum rating						
V _{RRM} repetitive peak reverse voltage 650							V
I _{O(AV)}	limiting average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 124 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>		40		А	
T _j	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	$I_F = 20 \text{ A}; T_j = 25 ^{\circ}\text{C}; \text{ per diode}; Fig. 5$		-	1.26	1.40	V
		I _F = 20 A; T _j = 150 °C; per diode; <u>Fig. 5</u>		-	1.35	1.55	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 20 \text{ A}$; $dI_F/dt = 500 \text{ A/µs}$; $V_R = 400 \text{ V}$; $T_i = 25 \text{ °C}$; per diode; Fig. 7		-	48	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode		
2	K	cathode		A1
3	A2	anode		K
mb	mb	mounting base; connected to cathode	1 2 3	sym125

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC6D40650CW-A	TO247	WNSC6D40650CW-A6Q	Tube	30	SOT429	25-Mar-2013

7. Marking

Table 4. Marking codes

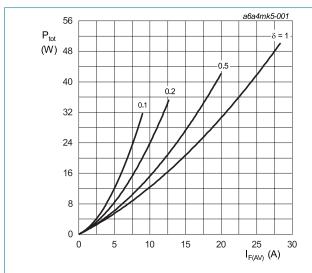
Type number	Marking codes
WNSC6D40650CW-A	WNSC6D 40650CW-A

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			650	V
V_{RWM}	crest working reverse voltage			650	V
V_R	reverse voltage	DC		650	V
I _{O(AV)}	limiting average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 124 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>		40	А
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 124 °C; square-wave pulse; per diode		40	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode		140	А
		t_p = 10 μ s; $T_{j(init)}$ = 25 °C; square-wave pulse; per diode		1000	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$		84.5	A ² s
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C



$$\begin{split} I_{\text{F(AV)}} &= I_{\text{F(RMS)}} \times \sqrt{\delta} \\ V_{\text{o}} &= 0.950 \text{ V; } R_{\text{s}} = 0.0289 \text{ } \Omega \end{split}$$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode

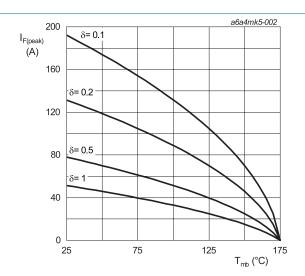
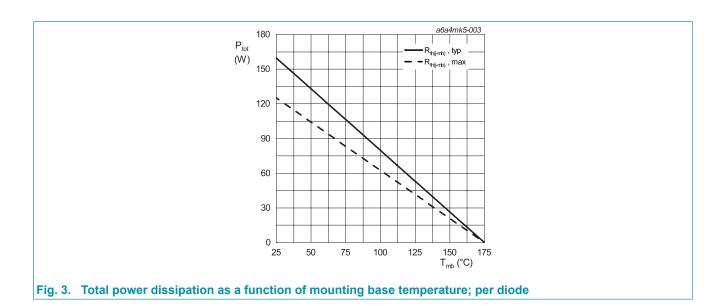


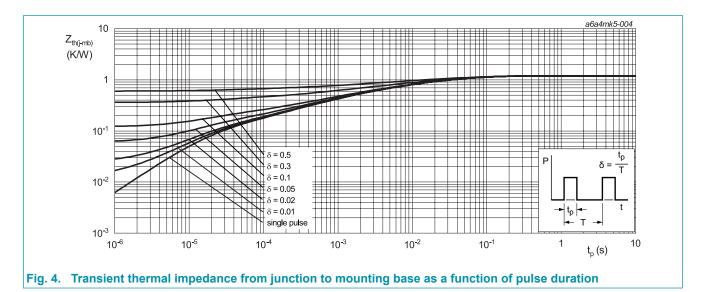
Fig. 2. Current derating as a function of mounting base temperature; per diode



9. Thermal characteristics

Table 6. Thermal characteristics

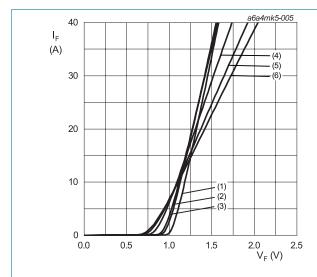
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance	per diode; Fig. 4		-	0.94	1.2	K/W
	from junction to mounting base	both diodes conducting		-	0.48	0.6	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W



10. Characteristics

Table 7. Characteristics

	_							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
Static cha	Static characteristics							
V_{F}	forward current	$I_F = 20 \text{ A}; T_j = 25 \text{ °C}; \text{ per diode}; Fig. 5$		-	1.26	1.40	V	
		I _F = 20 A; T _j = 150 °C; per diode; <u>Fig. 5</u>		-	1.35	1.55	V	
		I _F = 20 A; T _J = 175 °C; per diode; <u>Fig. 5</u>		-	1.40	1.60	V	
I _R	reverse current	V _R = 650 V; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	2	100	μΑ	
		V _R = 650 V; T _j = 175 °C; per diode; <u>Fig. 6</u>		-	30	400	μΑ	
Dynamic	characteristics							
Q_r	recovered charge	$I_F = 20 \text{ A}$; $V_R = 400 \text{ V}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; per diode; Fig. 7		-	48	-	nC	
C _d	diode capacitance	$f = 1 \text{ MHz}$; $V_R = 1 \text{ V}$; $T_j = 25 \text{ °C}$; per diode		-	1045	-	pF	
		$f = 1 \text{ MHz}$; $V_R = 300 \text{ V}$; $T_j = 25 \text{ °C}$; per diode		-	115	-	pF	
		$f = 1 \text{ MHz}$; $V_R = 600 \text{ V}$; $T_j = 25 \text{ °C}$; per diode		-	100	-	pF	
E _{as}	non-repetitive avalanche energy	I_R = 7.8 A; L = 5 mH; $T_{j(init)}$ = 25 °C; per diode		150	-	-	mJ	



 V_o = 0.950 V; R_s = 0.0289 Ω

(1) $T_j = -55$ °C; typical values

(2) T_j = 0 °C; typical values

(3) T_i = 25 °C; typical values

(4) T_i = 100 °C; typical values

(5) $T_j = 150$ °C; typical values

(6) T_i = 175 °C; typical values

Fig. 5. Forward current as a function of forward voltage; typical values; per diode

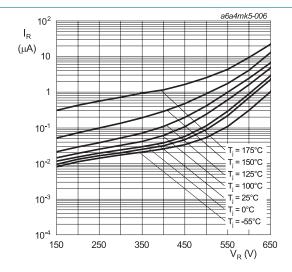


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value; per diode

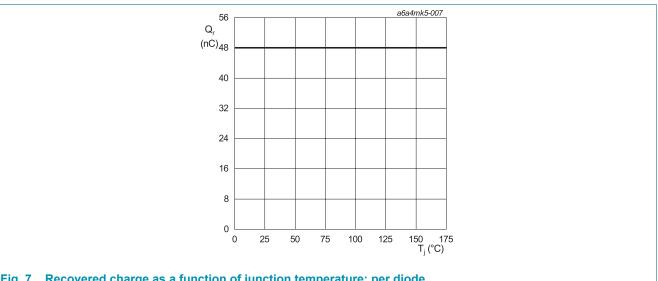
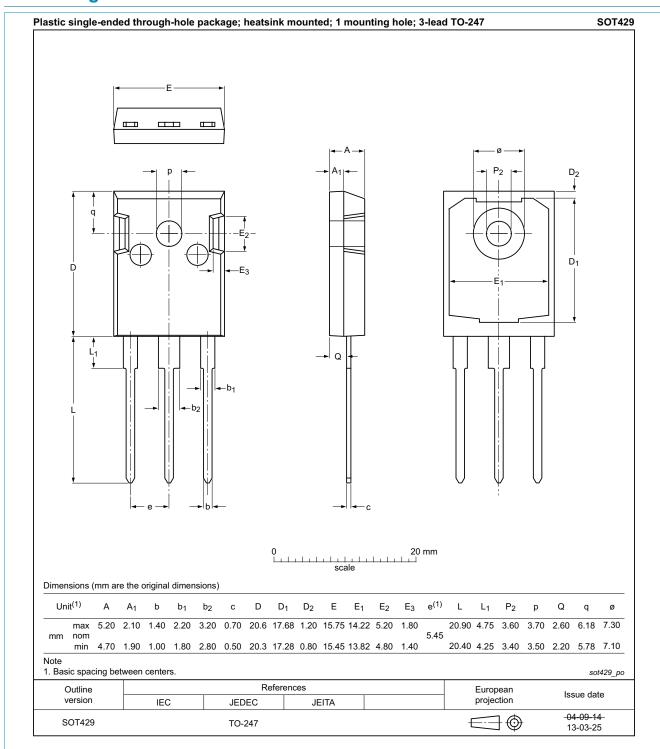


Fig. 7. Recovered charge as a function of junction temperature; per diode

11. Package outline



WNSC6D40650CW-A

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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